# Development of flat Silicon-based mesh-lens arrays for millimetre and submillimetre wave astronomy



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## Millimetre and Sub-mm wave arrays: Context

## Science:

- Cosmic Microwave Background (CMB) B-modes polarisation
- Next generation of CMB experiments will attempt to answer fascinating questions about fundamental physics and the Universe

## **Requirements:**

- High sensitivities, large arrays of polarisation sensitive detectors
- Multichroic operation for polarised foreground removal
- Accurate control and knowledge of systematic effects
  - **Current focal plane array coupling technologies:** 
    - Silicon platelet horns
    - Silicon hemispherical lenslets
    - Antenna-coupled phased-arrays
      - (Require scalability, easy fabrication, large bandwidths,...)

Novel coupling solution (this work): - Flat metamaterial lenslets



Focal plane arrays coupling technologies

Mesh-technology & mesh-lens array

Silicon-based mesh-lenslet arrays

Conclusions

# Available technology: Silicon platelet horns

J. W. Britton et al. (2012) J. P. Nibarger et al (2012) J. Hubmayr et al (2015)



### Working principle:

- Si platelet design of spline-profiled/corrugated horn antennas

### Manufacture:

- Etching circular apertures on Silicon wafers, stacking and Cu/Au plating 10 **Pros:** 

- Scalable, monolithic arrays (made 2k pixels), multi-chroic operation
- Accurate geometries achieved by photolithography
- High performance beams similar to electroformed horns
- Same thermal expansion of Si detector arrays
- Demonstrated in the field: STP-Pol, ACT-Pol

### Cons:

- Bandwidth limited by horn/OMT to ~80% (2.3:1); many layers required



## Si platelet feedhorn array

(~30-60, 254um)



X-pol

# Available technology: Hemispherical lenslets

Aritoki Suzuki et al. (2012)



### Working principle:

- Classical lens coupled to antenna (all within Silicon)

### Manufacture:

- Micromachined silicon lenses
- ARC manufactured using a mold then epoxied on the lens

### Pros:

- Demonstrated tri-chroic operation with sinuous antennas
- Operated in the field: POLARBEAR-1/2, SPT-3G, and DESHIMA

### Cons:

- Lenses produced individually then assembled (monolithic solutions..)
- CTE mismatch between 2-layer AR and Si lens (sometimes delaminating)
- Lower performance at high frequencies due to fabrication processes



## Si hemispherical lenslet array



# Available technology: Phase-array antennas

C. L. Kuo et al (2009) R. C. O'Brient et al. (2012) P. Ade et al. (2015)





### **One quarter** of detector element

### Working principle:

- Synthesised beam with coherently fed slot-antennas
- Signals combined with T-junctions into a microstrip

### Manufacture:

- All antennas fabricated via photolithographic processes
- Antennas as slots in superconducting Nb film, dual polarisation

### **Pros:**

- Optics integrated with filters and detectors (no horns/lenses)
- Operated in the field: BICEP, Keck Array, SPIDER

### Cons:

- Beam side-lobe levels require controlled 4K aperture stop
- The antenna bandwidth limited to 30% by microstrip circuitry
- End-to-end optical efficiency ~40%



## Focal plane arrays coupling technologies



Mesh-technology & Mesh-lens array

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# Mesh Lenses: Inhomogeneous phase delays





- Finite-element simulations showing the conversion of a spherical wavefront into a planar one



## Mesh Lenses: Large diameter devices



### Mesh Lens 3D beam tests

### $\downarrow$ Transversal cuts $\downarrow$



# Polypropylene embedded mesh-lenslet: Design





### **FEA model detail**

### Working principle:

- Local 'transmission-line' phase-delays
- Each column as a mesh-filter
- Phase-shifts optimised to mimic lens behaviour

## Manufacture:

- Copper evaporated on PP substrates
- Etching of the grids with variable pattern
- Hot bonding of the grids and PP spacers into a single device



## FEA simulation (HFSS)

# Mesh Lens Array: Prototype tests

ESA project - "Next Generation Sub-Millimetre Wave Focal Plane Array Coupling Concepts" – Maynooth (PI), Manchester, Cardiff, Rome, Paris APC & Chalmers



# Focal plane arrays coupling technologies

Mesh-technology & mesh-lens array



Silicon-based mesh-lenslet arrays

Conclusions

Silicon-based lenslet arrays: NASA APRA project



# Silicon etched-holes GRIN lenslet: Design





## Working principle:

- Graded-index Silicon lens
- Subwavelength vacuum holes
- Variable lower indices obtained by varying the hole diameters

## Manufacture:

- Etching of holes in Silicon wafers
- Possible to build ARC with larger etched holes



### **GRIN pattern example**

**FEA simulation** 

# Silicon etched-holes GRIN lenslet: Prototype tests



Etched-holes Si wafer (500um)

### Pros:

- Naturally matched to Si-based detectors

### Cons:

- Need ARC (Quartz or Si etched-hole layer)
- Smallest hole diameter limited by 10:1 aspect ratio of thickness-to-hole size
- Largest hole diameter limited by minimum thickness of the wall between the holes
- Above effects limit to frequencies up to ~170 GHz



19-pixel array prototype

6D beam

mapper

#### 2D beam measurements



# SiN air-gap mesh-lenslet: Design





Grid pattern example



## Working principle:

- Local 'transmission-line' phase-delays
- Each column behaves like a highly transmissive mesh-filter
- Phase-shifts optimised to mimic lens behaviour

## Manufacture:

- SiN films on Silicon wafers
- Copper grids evaporated/etched on SiN films
- Silicon apertures etched in correspondence of the grids



# SiN air-gap mesh-lenslet: Prototype tests



Individual layers and single pixel prototype

### Pros:

- Can be designed to be coupled to any antenna (need phase profile at lens entrance)
- Relatively easy to manufacture
- No need for ARC for free-space application

## Cons:

- Coupled to free-space source
- Need ARC to be used with Si detectors
- Design/code iterations required for low f#



### Lens Co-polar (E,H) & Cross-polar beams



# Silicon embedded mesh GRIN lenslet: Working principle





### FEA model (with sinuous antenna)

### Working principle:

- Graded-index Silicon lens
- Copper grids embedded in Silicon
- Variable higher indices obtained by varying the sizes of the Copper patches

### Manufacture:

- Copper grids evaporated on Si wafers
- Etched holes Silicon wafer for ARC layer



# Silicon embedded mesh GRIN lenslet: Prototype tests



### Pros:

7-pixel array prototype

- Naturally coupled to Si-based detectors
- Simple metal deposition scalable to high frequencies
- No air-gaps, no back etching, mechanically more robust

## Cons:

- Need ARC (Quartz or Si etched-hole layer)
- Large number of platelets (34) between 100-250 um thick

## Note:

- Only tested edge-lenslet (unable to use central bolometer)
- Asymmetry likely due to vacuum on the side



#### 2D beam measurements (edge lenslet)



- Investigating alternative solutions to current coupling technologies
- First attempt with etched-holes Si lenslets showed limits from the manufacture point of view
- Started to transfer the mesh-filters into the Silicon technology
- Successfully developed air-gap SiN mesh lenslet
- Very encouraging results from Si-embedded mesh-GRIN lenslet

What next?

- Design a Si-embedded mesh-lenslet to reduce the number of layers/grids
- More complex designs with arbitrary GRIN patterns with both transversal and longitudinal variability
- Mesh-GRIN hybrid solutions

# Grazie!